

DSM Series Ultra Thin Surface Mount Single Digit 7-Segment LED Display

DSM7UA20105 - 0.20" (5.08mm) Digit Height

Emitting Color: Pure Green (InGaN/GaN)

Applications

- People Movers
- Home Appliances
- Medical Devices
- Industrial Devices
- Automation and Controls
- Light Control

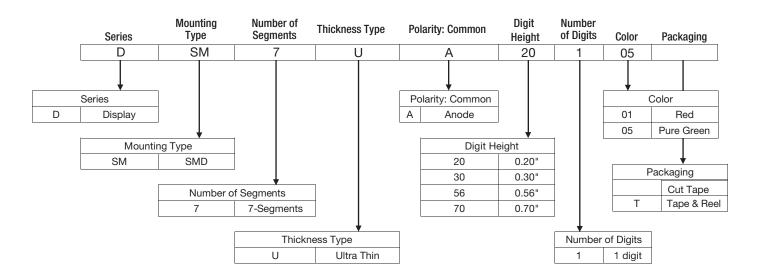
- IoT
- Transportation
- Food Service Appliances

Key Features

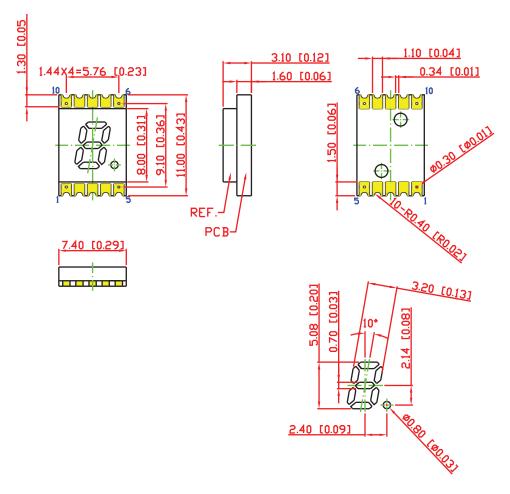
- 1-digit seven segment led numeric display
- Outer dimensions: 11.0 x 7.40 x 3.10mm
- Reduce overall thickness of PCB, with major cost savings
- Available in 4 different digit heights and widths
- Excellent character appearance, with high light output
- Pure green chip
- Made from InGaN on transparent GaN substrate
- Made of white segments and gray surface
- Also available in super bright red
- Available in cut tape or automation-friendly tape and reel
- Display surface color: black surface and white segments

- Exclusive patented technology
- Low current operation and lower power consumption
- Polarity: common anode
- Available for reverse mounting configuration
- Side by side mounting allows space saving
- Easy mounting on PC boards or sockets
- Moisture Sensitive Level (MSL): 2a
- Life expectancy: 100,000 hours
- Technically and mechanically rugged
- Quality tested with the highest industry standard

Ordering Data



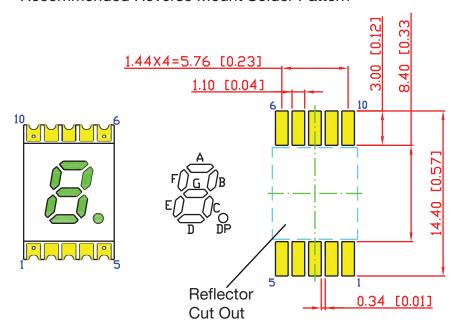
Dimensions and Internal Circuit Diagram



 $\label{eq:Dimensions} \mbox{Dimensions in millimeters [inches]} \\ \mbox{Tolerance is $\pm 0.25 mm [.01"] unless otherwise noted}$

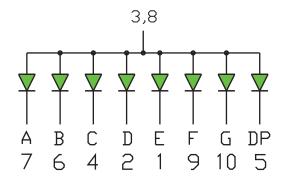
Dimensions and Internal Circuit Diagram

Recommended Reverse Mount Solder Pattern



 $\label{eq:Dimensions} \mbox{Dimensions in millimeters [inches]} \\ \mbox{Tolerance is $\pm 0.25 mm [.01"] unless otherwise noted}$

Pin Connections (Common Anode)



| PIN No | Connection |
|--------|--------------|
| 1 | CATHODE E |
| 2 | CATHODE D |
| 3 | COMMON ANODE |
| 4 | CATHODE C |
| 5 | CATHODE DP |
| 6 | CATHODE B |
| 7 | CATHODE A |
| 8 | COMMON ANODE |
| 9 | CATHODE F |
| 10 | CATHODE G |

Product Specifications

Absolute Maximum Rating at Ta=25°C / 77°F (Ta= Ambient Temperature)

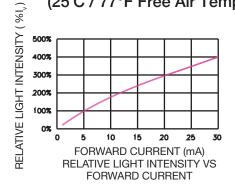
| Parameter | Symbol | Maximum Rating | Unit |
|--------------------------------------|------------------|----------------------------|------------|
| Power dissipation | P _{AD} | 120 | mW |
| Derating liner from 25°C/77°F | - | 0.30/9.46 | mA °C / °F |
| Continuous forward current | I _{AF} | 30 | mA |
| Peak current (duty cycle 1/10, 1kHz) | I _{PF} | 100 | mA |
| Reverse voltage | V _R | 5 | V |
| Operating temperature | T _{OPR} | -40 TO +105 -40 TO +221 | °C °F |
| Storage temperature | T _{STG} | -40 TO +105 -40 TO +221 | °C °F |

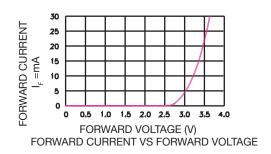
Electrical - Optical Characteristics at Ta=25°C / 77°F (Ta= Ambient Temperature)

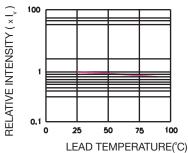
| Charateristic | Symbol | Condition | Min. | Тур. | Max. | Unit |
|------------------------------|----------------|----------------------|------|------|------|------|
| Forward Voltage, (Per Dice) | V _F | I _F =20mA | - | 2.8 | 3.6 | V |
| Reverse Current, (Per Dice) | I _R | V _R =8V | - | - | 10 | μΑ |
| Dominant Wavelength | λ_{D} | I _F =20mA | 515 | - | 530 | nm |
| Luminous Intensity | I _v | I _F =20mA | 40 | - | 100 | mcd |
| Spectral radiation bandwidth | Δλ | I _F =20mA | - | 30 | - | nm |

Product Specifications

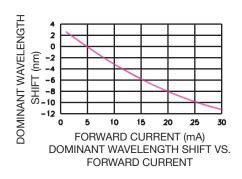
Typical Electro-optical Characteristic Curves (25°C / 77°F Free Air Temperature Unless Otherwise Specified)

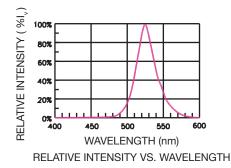


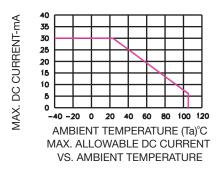




LEAD TEMPERATURE(°C)
RELATIVE INTENSITY VS LEAD TEMPERATURE
(PULSED 20mA; 300us PULSE, 10ms PERIOD)

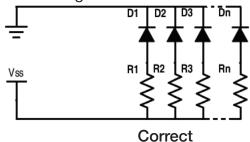


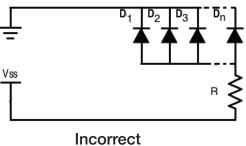




Circuit Design Notes

- · Always use current limit resistors when necessary
- LEDs could be electrically connected in parallel, with each LED having its own current limiting resistor



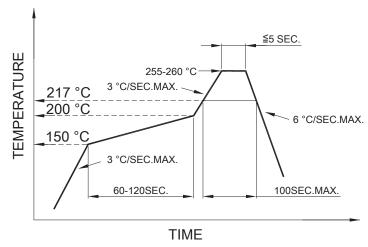


Recommended Reflow Soldering Profile

SMT Reflow Soldering Instructions

SMT Soldering Profile

Pb free reflow soldering Profile



- We recommend the reflow temperature 245°C / 473°F (+/- 5°C / 41°F). The maximum soldering temperature should be limited to 260°C / 500°F.
- · Number of reflow process shall be 2 time or less.

Soldering Iron

Basic spec is \leq 4 sec when 260°C / 500°F. If temperature is higher, time should be shorter (+10°C / 50°F →1 sec). Power dissipation of Iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C /446°F.

Rework

- Customer must finish rework within 3 sec. under 350°C / 662°F.
- The head of soldering iron cannot touch copper foil.

Storage Condition

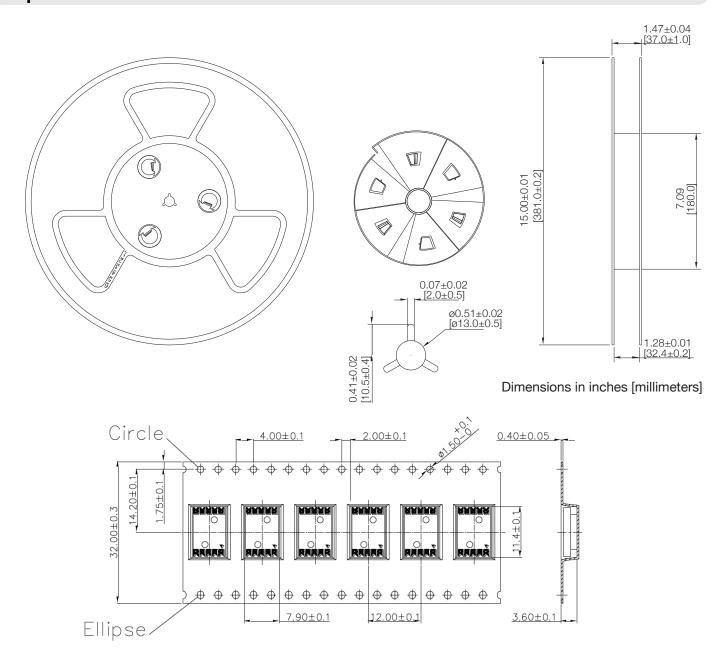
In factory original sealed bag package

| TEMPERATURE CONDITION | HUMIDITY CONDITION |
|-----------------------|--------------------|
| 5°C ~ 30°C | Below 60%RH |

After opened and not in factory original sealed bag package

| TEMPERATURE CONDITION | HUMIDITY CONDITION | STORAGE TIME |
|-----------------------|--------------------|----------------------------------|
| 5°C ~ 30°C | Below 60%RH | Within 4 weeks (MSL as level 2a) |

Tape & Reel Dimensions



1350PCS / 1 REEL

Dimensions in millimeters

Compliance and Approvals







